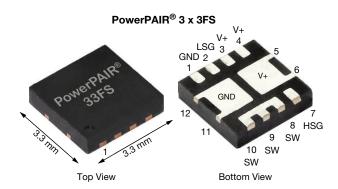
COMPLIANT

FREE



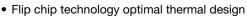
Dual N-Channel 30 V (D-S) MOSFET

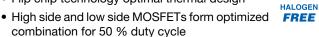


PRODUCT SUMMARY					
V _{DS} (V)	30				
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 10 \text{ V}$	0.0032				
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 4.5 \text{ V}$	0.0053				
Q _g typ. (nC)	6.7				
I _D (A)	100 ^a				
Configuration	Dual				

FEATURES

- TrenchFET® Gen V power MOSFET
- Symmetric dual N-channel

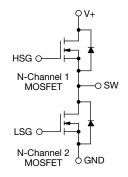




- $\bullet\,$ Optimized R_{DS} Q_g and R_{DS} Q_{gd} FOM elevates efficiency for high frequency switching
- 100 % R_g and UIS tested
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Synchronous buck
- Computer / server peripherals
- Half bridge
- POL
- Telecom DC/DC



ORDERING INFORMATION	
Package	PowerPAIR 3 x 3FS
Lead (Pb)-free and halogen-free	SiZF5302DT-T1-RE3

PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-source voltage		V _{DS}	30	V	
Gate-source voltage		V _{GS}	+16 / -12		
Continuous drain current (T _J = 150 °C)	T _C = 25 °C		100		
	T _C = 70 °C		80		
	T _A = 25 °C	I _D	28.1 b, c		
	T _A = 70 °C		22.5 b, c		
Pulsed drain current (t = 100 μs)		I _{DM}	150	A	
Continuous source current (MOSFET diode conduction)	T _C = 25 °C		40.1		
	T _A = 25 °C	I _S	3.2 b, c		
Single pulse avalanche current	L = 0.1 mH	I _{AS}	17		
Single pulse avalanche energy	L = 0.1 min	E _{AS}	14.45	mJ	
Maximum power dissipation	T _C = 25 °C		48.1		
	T _C = 70 °C	D	30.8	w	
	T _A = 25 °C	P _D	3.8 b, c	VV	
	T _A = 70 °C		2.4 b, c		
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150		
Soldering recommendations (peak temperature)		ŭ	260	— °C	

Notes

- a. $T_C = 25 \,^{\circ}C$
- b. Surface mounted on 1" x 1" FR4 board

S22-0207-Rev. A, 28-Feb-2022

c. t = 10 s



Vishay Siliconix

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient a, b	t ≤ 10 s	R _{thJA}	26	33	°C/W
Maximum junction-to-case (drain)	Steady state	R _{thJC}	2	2.6	C/ VV

Notes

- a. Surface mounted on 1" x 1" FR4 board
- b. Maximum under steady state conditions is 67 °C/W

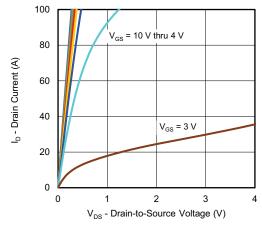
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static				•			
Drain-source breakdown voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_{D} = 1 \text{ mA}$	30	-	-	V	
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1	-	2	v	
Gate-source leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = +16 \text{ V} / -12 \text{ V}$	-	-	± 100	nA	
Zana anto coltano durio accument		V _{DS} = 24 V, V _{GS} = 0 V	-	-	1	μА	
Zero gate voltage drain current	I _{DSS}	V _{DS} = 24 V, V _{GS} = 0 V, T _J = 55 °C	-	-	5		
On-state drain current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	30	-	-	Α	
Duning and a state of the state	Б	V _{GS} = 10 V, I _D = 10 A	-	0.0027	0.0032	Ω	
Drain-source on-state resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 7 \text{ A}$	-	0.0044	0.0053		
Forward transconductance ^a	9 _{fs}	V _{DS} = 10 V, I _D = 10 A	=	57	-	S	
Dynamic ^b							
Input capacitance	C _{iss}		-	1030	-	pF	
Output capacitance	C _{oss}		=	340	-		
Reverse transfer capacitance	C _{rss}	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	30	-		
C _{rss} /C _{iss} ratio			-	0.028	0.055		
Tatal acts chares	0	V _{DS} = 15 V, V _{GS} = 10 V, I _D = 20 A	-	14.8	22.2		
Total gate charge	Qg		-	6.7	10.0		
Gate-source charge	Q _{gs}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 20 \text{ A}$	-	3.8	-		
Gate-drain charge	Q _{gd}		-	1.12	-		
Gate resistance	R_g	f = 1 MHz	0.24	1.2	2.4	Ω	
Turn-on delay time	t _{d(on)}		-	10	20		
Rise time	t _r	$V_{DD} = 15 \text{ V}, R_1 = 1 \Omega, I_D \cong 15 \text{ A},$	-	6	12		
Turn-off delay time	t _{d(off)}	$V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	-	23	46		
Fall time	t _f		-	6	12		
Turn-on delay time	t _{d(on)}		-	20	40	ns	
Rise time	t _r	$\begin{split} V_{DD} = 15 \text{ V, } R_L = 1 \Omega \text{, } I_D \cong 15 \text{ A,} \\ V_{GEN} = 4.5 \text{ V, } R_g = 1 \Omega \end{split}$	-	45	90		
Turn-off delay time	t _{d(off)}		-	20	40		
Fall time	t _f		-	12	24		
Drain-source Body Diode Characteris	tics			•			
Continuous source-drain diode current	I _S	T _C = 25°C	-	-	40.1	٨	
Pulse diode forward current	I _{SM}		-	-	150	Α	
Body diode voltage	V_{SD}	I _S = 15 A, V _{GS} = 0 V	-	0.85	1.2	V	
Body diode reverse recovery time	t _{rr}		-	13	26	ns	
Body diode reverse recovery charge	Q _{rr}	I _F = 15 A, di/dt = 100 A/µs,	-	3	6	nC	
Reverse recovery fall time	ta	T _J = 25 °C	-	6	-		
Reverse recovery rise time	t _b		-	7	-	ns	

Notes

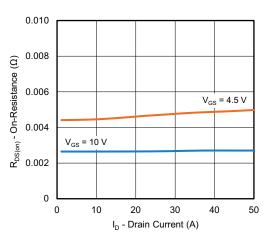
- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

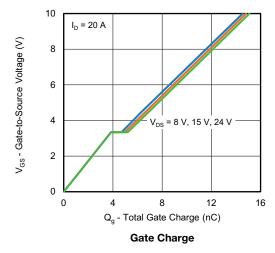


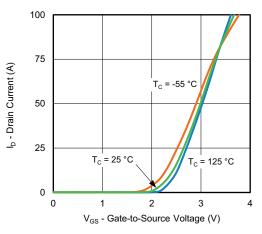


Output Characteristics

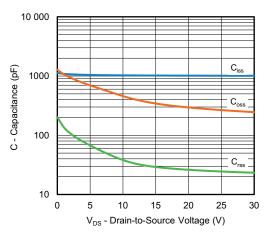


On-Resistance vs. Drain Current and Gate

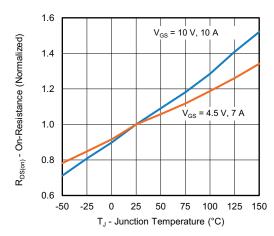




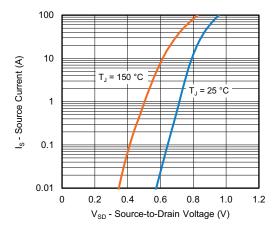
Transfer Characteristics



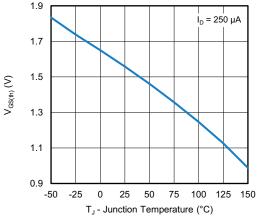
Capacitance



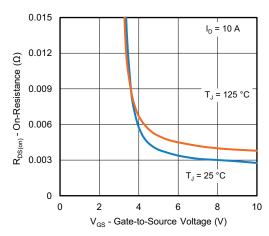
On-Resistance vs. Junction Temperature



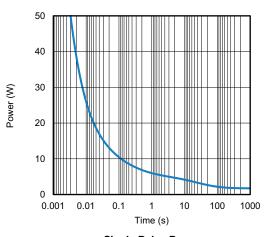
Source-Drain Diode Forward Voltage



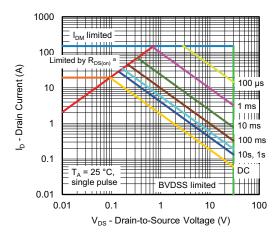
Threshold Voltage



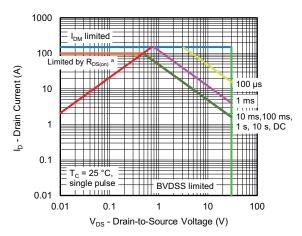
On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power



Safe Operating Area, Junction-to-Ambient

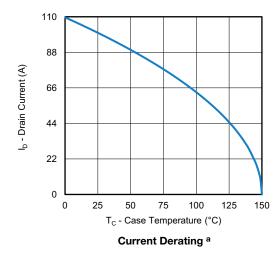


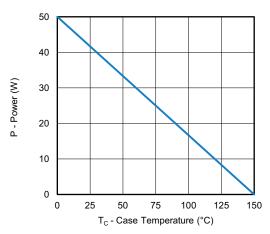
Safe Operating Area, Junction-to-Case

Note

a. $V_{GS} > minimum \ V_{GS}$ at which $R_{DS(on)}$ is specified





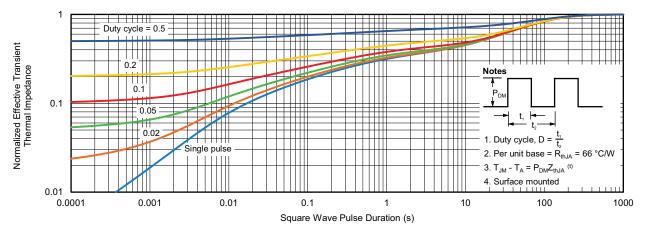


Power, Junction-to-Case

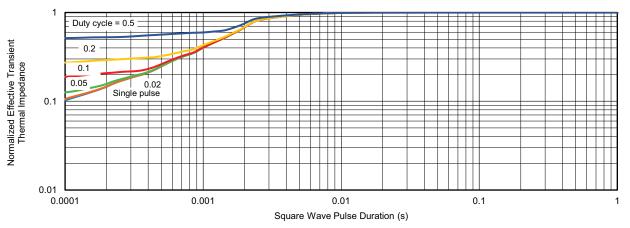
Notes

- a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-ambient thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit
- b. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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